

TOSHIBA GTR MODULE SILICON N CHANNEL IGBT

MG200Q1US51

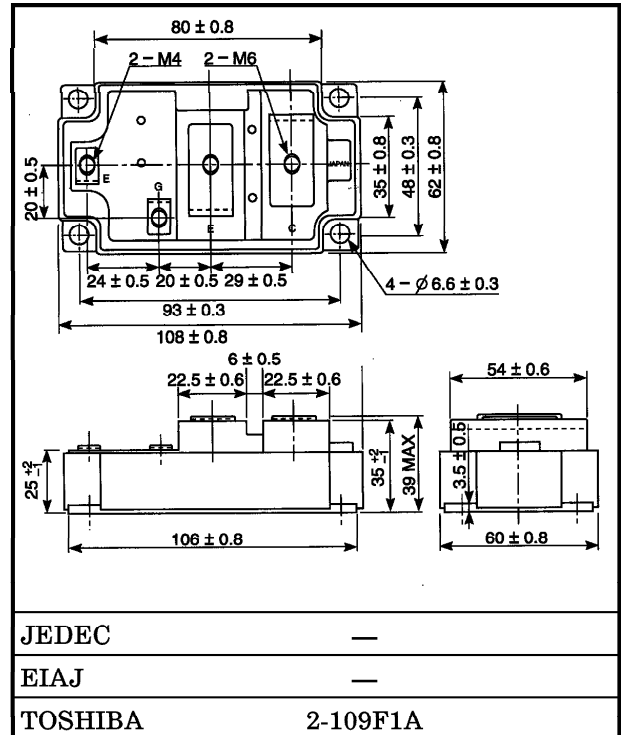
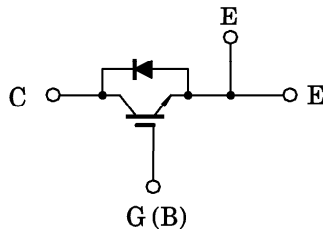
HIGH POWER SWITCHING APPLICATIONS

Unit in mm

MOTOR CONTROL APPLICATIONS

- High Input Impedance
- High Speed : $t_f = 0.3\mu s$ (Max.)
@Inductive Load
- Low Saturation Voltage
: $V_{CE(sat)} = 3.6V$ (Max.)
- Enhancement-Mode
- The Electrodes are Isolated from Case.

EQUIVALENT CIRCUIT



Weight : 465g

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Emitter Voltage	V_{CES}	1200	V
Gate-Emitter Voltage	V_{GES}	±20	V
Collector Current	DC	I_C (25°C / 80°C)	300 / 200
	1ms	I_{CP} (25°C / 80°C)	600 / 400
Forward Current	DC	I_F	200
	1ms	I_{FM}	400
Collector Power Dissipation (Tc = 25°C)	P_C	1500	W
Junction Temperature	T_j	150	°C
Storage Temperature Range	T_{stg}	-40~125	°C
Isolation Voltage	V_{Isol}	2500 (AC 1 minute)	V
Screw Torque (Terminal : M4 / M6 / Mounting)	—	2 / 3 / 3	N·m

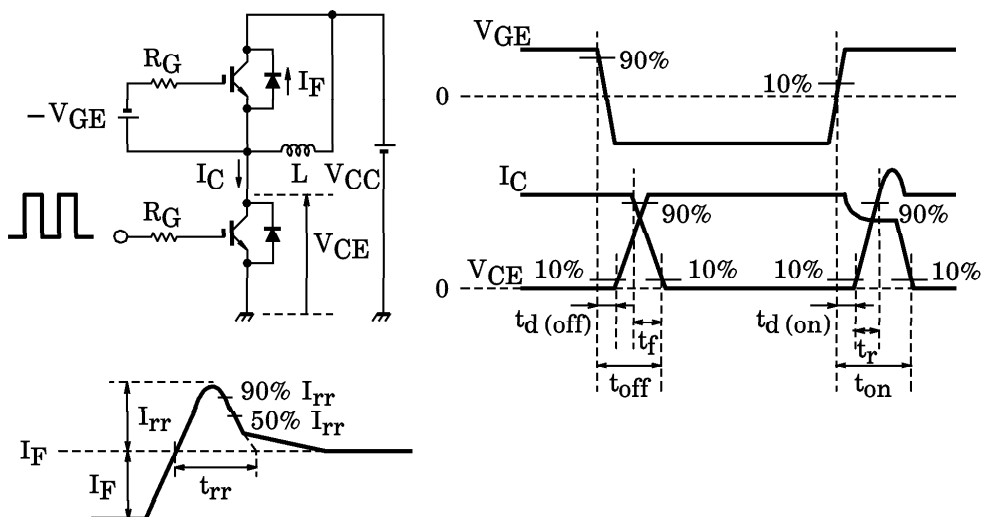
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ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT	
Gate Leakage Current	I_{GES}	$V_{GE} = \pm 20V, V_{CE} = 0$	—	—	± 500	nA	
Collector Cut-off Current	I_{CES}	$V_{CE} = 1200V, V_{GE} = 0$	—	—	4.0	mA	
Gate-Emmitter Cut-off Voltage	$V_{GE} (off)$	$I_C = 200mA, V_{CE} = 5V$	3.0	—	6.0	V	
Collector-Emmitter Saturation Voltage	$V_{CE} (sat)$	$I_C = 200A, V_{GE} = 15V$	$T_j = 25^\circ C$	—	2.8	3.6	V
			$T_j = 125^\circ C$	—	3.1	4.0	
Input Capacitance	C_{ies}	$V_{CE} = 10V, V_{GE} = 0, f = 1MHz$	—	24.0	—	nF	
Switching Time	Turn-on Delay Time	Inductive Load $V_{CC} = 600V$ $I_C = 200A$ $V_{GE} = \pm 15V$ $R_G = 4.7\Omega$ (Note 1)	—	0.05	—	μs	
	Rise Time		—	0.05	—		
	Turn-on Time		—	0.2	—		
	Turn-off Delay Time		—	0.5	—		
	Fall Time		—	0.1	0.3		
	Turn-off Time		—	0.6	—		
Forward Voltage	V_F	$I_F = 200A, V_{GE} = 0$	—	2.4	3.5	V	
Reverse Recovery Time	t_{rr}	$I_F = 200A, V_{GE} = -10V$ $di/dt = 700A/\mu s$ (Note 1)	—	0.15	0.3	μs	
Thermal Resistance	$R_{th} (j-c)$	Transistor Stage	—	—	0.08	$^\circ C/W$	
		Diode Stage	—	—	0.24		

(Note 1) Switching Time and Reverse Recovery Time Test Circuit & Timing Chart



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